

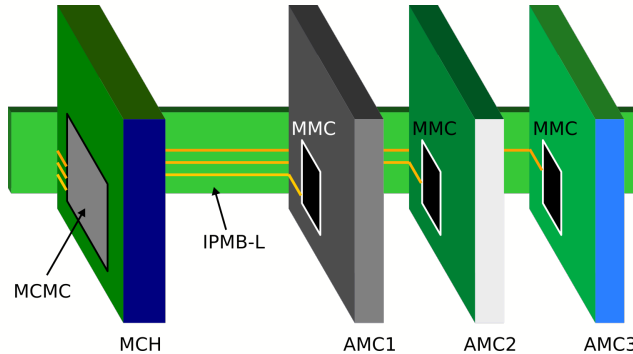


Overview of MMC Stamp software development kit.

Patrick Huesmann (DESY) 2021-12-09

10th MicroTCA Workshop, Hamburg

One of most important features of MicroTCA is out-of-band management interface.



MicroTCA Carrier Management Controller (MCMC) (part of MicroTCA Carrier Hub - MCH) connects to Module Management Controller (MMC) on Advanced Mezzanine Card (AMC) over IPMB-L

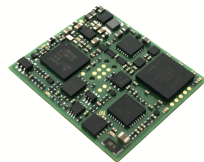
from: MMC Stamp and its applications, J. Marjanovic, MTCA Workshop China 2019

- ▶ 2014: Legacy MMC
 - ▶ Original code based on a version from DESY MCS department
 - ▶ Many contributions, e.g. from NCBJ, DMCS@TUL
 - ▶ MMC components scattered across AMC board
 - ▶ MMC-related HW not standardized

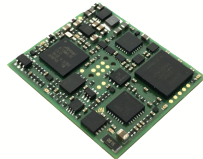


- ▶ 2014: Legacy MMC
 - ▶ Original code based on a version from DESY MCS department
 - ▶ Many contributions, e.g. from NCBJ, DMCS@TUL
 - ▶ MMC components scattered across AMC board
 - ▶ MMC-related HW not standardized

- ▶ 2018: Standardization of hardware → MMC Stamp
 - ▶ Unified hardware platform (SoM, same HW across all AMC boards)
 - ▶ All management-related components on a single high-density board
 - ▶ Upgraded MCU to ARM Cortex-M4 (much more powerful than AVR)



- ▶ 2014: Legacy MMC
 - ▶ Original code based on a version from DESY MCS department
 - ▶ Many contributions, e.g. from NCBJ, DMCS@TUL
 - ▶ MMC components scattered across AMC board
 - ▶ MMC-related HW not standardized
- ▶ 2018: Standardization of hardware → MMC Stamp
 - ▶ Unified hardware platform (SoM, same HW across all AMC boards)
 - ▶ All management-related components on a single high-density board
 - ▶ Upgraded MCU to ARM Cortex-M4 (much more powerful than AVR)
- ▶ 2020: Standardization of software → MMC Stamp SDK
 - ▶ Existing codebase converted into shared MMC library
 - ▶ APIs created for board implementation
 - ▶ Added support for binary distribution of core library



- ▶ IPMI control, Hotplug events
- ▶ FRU information (AMC, RTM, FMCs)

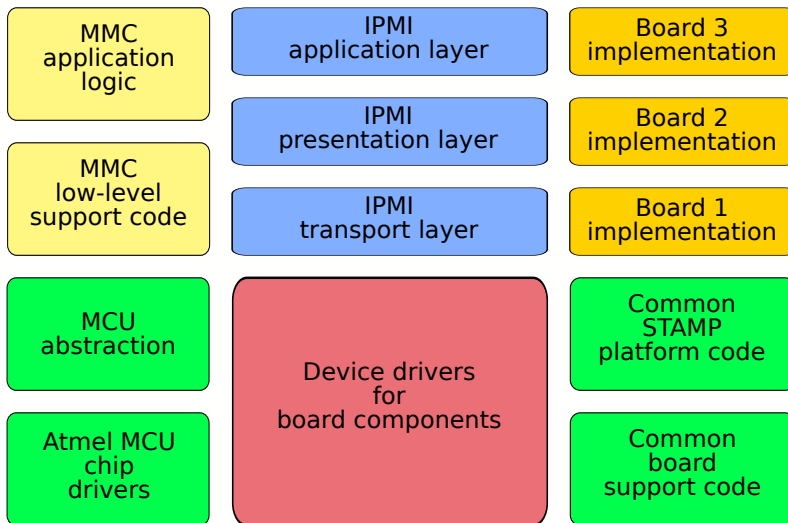
- ▶ IPMI control, Hotplug events
- ▶ FRU information (AMC, RTM, FMCs)
- ▶ Sensors, thresholds & alerts
 - ▶ temperatures
 - ▶ voltages
 - ▶ currents
 - ▶ pin levels ...

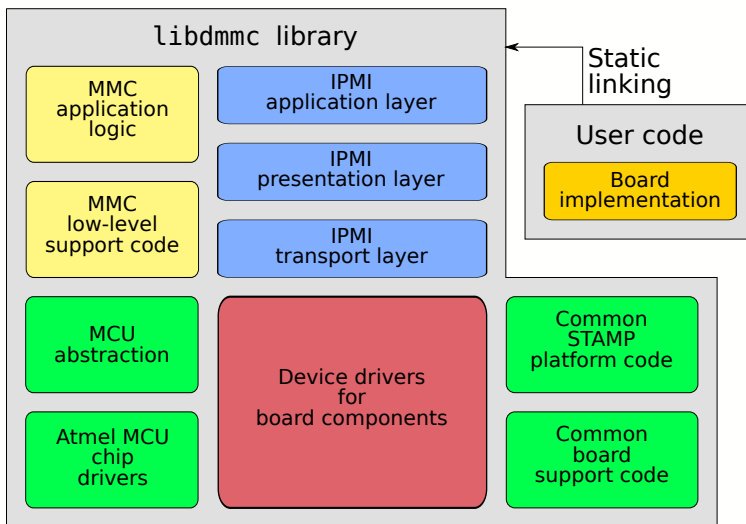
```
nat> show_sensorinfo 10
Sensor Information for FRU 10 / AMC6
-----
#   SDRType  Sensor Entity Inst Value State Name
-----
-   MDevLoc           0xc1 0x66
0   Full      0xf2 0xc1 0x66 0x00      AMC Hot Swap
1   Compact  0x0b 0xc1 0x66 0x00      0x00 801F12F0B063
2   Full      Temp  0xc1 0x66 26.0 C    ok      STAMP Temp
3   Full      Voltage 0xc1 0x66 3.352 V   ok      AMC MP 3V3
4   Full      Voltage 0xc1 0x66 12.44 V   ok      AMC PP 12V
5   Full      Current 0xc1 0x66 0.004 A   ok      I_RTM MP 3V3
6   Full      Current 0xc1 0x66 0.00 A    ok      I_RTM PP 12V
7   Compact  0x14 0xc1 0x66 0x01      0x00 CPLD Done
8   Compact  0x14 0xc1 0x66 0x01      0x00 RTM MP 3V3 PG
9   Compact  0x14 0xc1 0x66 0x00      0x00 RTM PP 12V PG
10  Compact  0x14 0xc1 0x66 0x00      0x00 RTM Fault
11  Compact  0x14 0xc1 0x66 0x01      0x00 PGood_A
12  Compact  0x14 0xc1 0x66 0x01      0x00 PGood_B
13  Compact  0x14 0xc1 0x66 0x00      0x00 FPGA1 Init
14  Compact  0x14 0xc1 0x66 0x00      0x00 FPGA1 Done
15  Compact  0x14 0xc1 0x66 0x00      0x00 FPGA2 Init
16  Compact  0x14 0xc1 0x66 0x00      0x00 FPGA2 Done
17  Full      Temp  0xc1 0x66 31.5 C    ok      Inlet Temp
18  Full      Temp  0xc1 0x66 29.0 C    ok      Outlet Temp
19  Full      Temp  0xc1 0x66 32.5 C    ok      LTM4630 Temp
20  Full      Temp  0xc1 0x66 34.0 C    ok      LTM4650 Temp
21  Full      Temp  0xc1 0x66 37.5 C    ok      LTM4633_F Temp
22  Full      Temp  0xc1 0x66 38.0 C    ok      LTM4633_R Temp
23  Full      Temp  0xc1 0x66 36.5 C    ok      ZUP IC Temp
24  Full      Temp  0xc1 0x66 38.0 C    ok      S7 IC Temp
...
-----
```

- ▶ IPMI control, Hotplug events
- ▶ FRU information (AMC, RTM, FMCs)
- ▶ Sensors, thresholds & alerts
 - ▶ temperatures
 - ▶ voltages
 - ▶ currents
 - ▶ pin levels ...
- ▶ Payload management
 - ▶ Power management, start/stop payload
 - ▶ Custom CLI commands
 - ▶ Custom IPMI commands
 - ▶ Firmware update of payload (HPM)

```
nat> show_sensorinfo 10
Sensor Information for FRU 10 / AMC6
-----
#   SDRType  Sensor Entity Inst Value State Name
-----
-   MDevLoc          0xc1 0x66
0   Full      0xf2 0xc1 0x66 0x00      AMC Hot Swap
1   Compact   0x0b 0xc1 0x66 0x00      0x00 801F12F0B063
2   Full      Temp  0xc1 0x66 26.0 C    ok      STAMP Temp
3   Full      Voltage 0xc1 0x66 3.352 V   ok      AMC MP 3V3
4   Full      Voltage 0xc1 0x66 12.44 V   ok      AMC PP 12V
5   Full      Current 0xc1 0x66 0.004 A   ok      I_RTM MP 3V3
6   Full      Current 0xc1 0x66 0.00 A    ok      I_RTM PP 12V
7   Compact   0x14 0xc1 0x66 0x01      0x00 CPLD Done
8   Compact   0x14 0xc1 0x66 0x01      0x00 RTM MP 3V3 PG
9   Compact   0x14 0xc1 0x66 0x00      0x00 RTM PP 12V PG
10  Compact   0x14 0xc1 0x66 0x00      0x00 RTM Fault
11  Compact   0x14 0xc1 0x66 0x01      0x00 PGood_A
12  Compact   0x14 0xc1 0x66 0x01      0x00 PGood_B
13  Compact   0x14 0xc1 0x66 0x00      0x00 FPGA1 Init
14  Compact   0x14 0xc1 0x66 0x00      0x00 FPGA1 Done
15  Compact   0x14 0xc1 0x66 0x00      0x00 FPGA2 Init
16  Compact   0x14 0xc1 0x66 0x00      0x00 FPGA2 Done
17  Full      Temp  0xc1 0x66 31.5 C    ok      Inlet Temp
18  Full      Temp  0xc1 0x66 29.0 C    ok      Outlet Temp
19  Full      Temp  0xc1 0x66 32.5 C    ok      LTM4630 Temp
20  Full      Temp  0xc1 0x66 34.0 C    ok      LTM4650 Temp
21  Full      Temp  0xc1 0x66 37.5 C    ok      LTM4633_F Temp
22  Full      Temp  0xc1 0x66 38.0 C    ok      LTM4633_R Temp
23  Full      Temp  0xc1 0x66 36.5 C    ok      ZUP IC Temp
24  Full      Temp  0xc1 0x66 38.0 C    ok      S7 IC Temp
...
-----
```

see also: http://www.rehlich.com/MicroTCA_IPMI_management





Features supported by **standard** MMC STAMP firmware out of the box:

- ▶ MCH comm, LEDs, power, RTM control
- ▶ On-board STAMP sensors
- ▶ Custom FRU read/write (AMC/RTM)

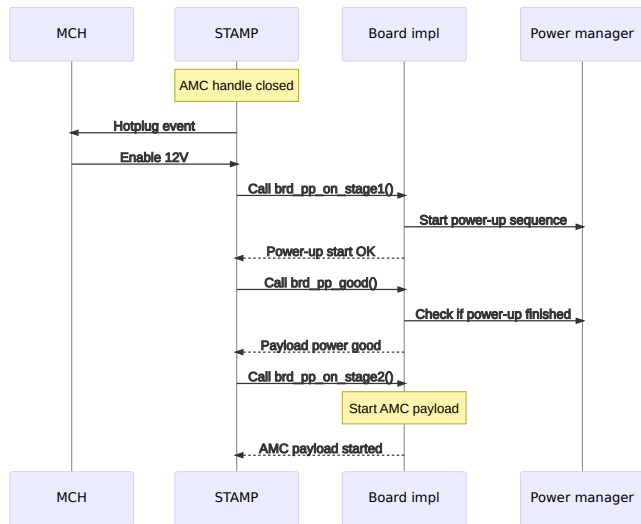
Features supported by **standard** MMC STAMP firmware out of the box:

- ▶ MCH comm, LEDs, power, RTM control
- ▶ On-board STAMP sensors
- ▶ Custom FRU read/write (AMC/RTM)

Features requiring a **board-specific** firmware using MMC STAMP SDK:

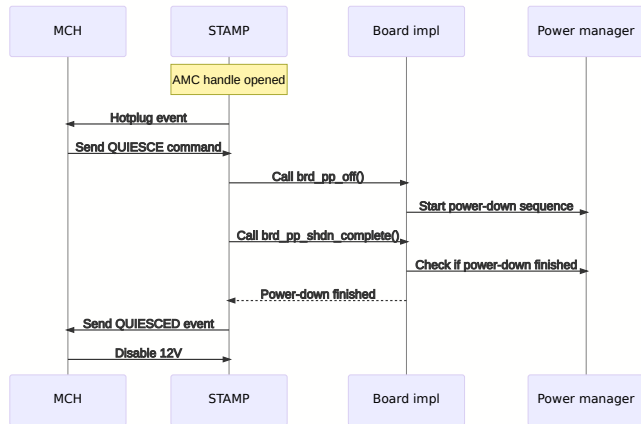
- ▶ Additional sensors on user board
- ▶ MAC address forwarding to user FPGA
- ▶ Payload power sequencing
- ▶ User-specific GPIO control (MCU, CPLD)
- ▶ In-application update of payload via HPM.1
- ▶ Custom CLI commands
- ▶ Custom IPMI commands

MMC SDK: Power management



Board implementation:

- ▶ `brd_pp_on_stage1()`
Start power-up sequence
- ▶ `brd_pp_good()`
Check if power-up sequence finished
- ▶ `brd_pp_on_stage2()`
Start the board payload
- ▶ `brd_set_z3_drv_enable()`
Zone 3 interface enable/disable



Board implementation:

- ▶ `brd_pp_off()`
Start power-down sequence
- ▶ `brd_pp_shdn_complete()`
Check if power-down sequence is finished

MMC SDK: Sensor API

Two kinds of IPMI sensors:

- ▶ "Compact" sensors (only 0 and 1)
- ▶ "Full" sensors (numerical value)

```
$ ipmitool -H mskmchhvfl.tech.lab -A NONE -B 0 -T 0x82 -t 0x7c -b 7 sensor
...
RTM MP 3V3 PG      | 0x1          | discrete | 0x0000| na      | na      | na      | na      | na      | na
RTM PP 12V PG     | 0x0          | discrete | 0x0000| na      | na      | na      | na      | na      | na
...
```

Two kinds of IPMI sensors:

- ▶ "Compact" sensors (only 0 and 1)
- ▶ "Full" sensors (numerical value)

Full sensors provide a numeric reading w/ engineering unit, range and thresholds

- ▶ Sensor type: Voltage, Current or Temperature
- ▶ Can be I2C sensor or STAMP analog input
- ▶ Callbacks for read fn and optional enable / postprocessing fn

```
$ ipmitool -H mskmchhvfi.tech.lab -A NONE -B 0 -T 0x82 -t 0x7c -b 7 sensor
...
RTM MP 3V3 PG      | 0x1      | discrete | 0x0000 | na      | na      | na      | na      | na      | na
RTM PP 12V PG     | 0x0      | discrete | 0x0000 | na      | na      | na      | na      | na      | na
...
Inlet Temp        | 24.000   | degrees C | ok     | 0.000  | 3.000   | 5.000   | 60.000  | 70.000  | 75.000
Outlet Temp       | 22.000   | degrees C | ok     | 0.000  | 3.000   | 5.000   | 60.000  | 70.000  | 75.000
LTM4630 Temp      | 26.000   | degrees C | ok     | 0.000  | 3.000   | 5.000   | 60.000  | 70.000  | 75.000
LTM4650 Temp      | 26.500   | degrees C | ok     | 0.000  | 3.000   | 5.000   | 60.000  | 70.000  | 75.000
...
VCC_1V2           | 1.200    | Volts     | ok     | 1.018  | 1.075   | 1.133   | 1.258   | 1.315   | 1.373
...
```

Sensors supported by MMC STAMP SDK out of the box:

- ▶ STAMP analog inputs (built-in ADC of MCU), STAMP GPIOs
- ▶ External ADCs & temp. sensors (I2C)

Sensors supported by MMC STAMP SDK out of the box:

- ▶ STAMP analog inputs (built-in ADC of MCU), STAMP GPIOs
- ▶ External ADCs & temp. sensors (I2C):
 - ▶ MAX6626 Local temp.
→ Standard for RTMs
 - ▶ LM95214 Remote diode & local temp.
→ Typical use: Measuring IC temperatures (e.g. of big FPGAs)
 - ▶ ADS101x 12bit ADC
→ Typical use: Reading DC/DC temperature monitoring outputs
 - ▶ ADT7411 10bit ADC & local temp.
→ Used on some FMCs, e.g. 4DSP FMC116

Sensors supported by MMC STAMP SDK out of the box:

- ▶ STAMP analog inputs (built-in ADC of MCU), STAMP GPIOs
- ▶ External ADCs & temp. sensors (I2C):
 - ▶ MAX6626 Local temp.
 - Standard for RTMs
 - ▶ LM95214 Remote diode & local temp.
 - Typical use: Measuring IC temperatures (e.g. of big FPGAs)
 - ▶ ADS101x 12bit ADC
 - Typical use: Reading DC/DC temperature monitoring outputs
 - ▶ ADT7411 10bit ADC & local temp.
 - Used on some FMCs, e.g. 4DSP FMC116
- ▶ Power manager:
 - ▶ LTC297x (PMBUS) family supported
 - ▶ Built-in monitoring channels
 - ▶ Support for voltage, current and temperature monitoring

Sensors supported by MMC STAMP SDK out of the box:

- ▶ STAMP analog inputs (built-in ADC of MCU), STAMP GPIOs
- ▶ External ADCs & temp. sensors (I2C):
 - ▶ MAX6626 Local temp.
→ Standard for RTMs
 - ▶ LM95214 Remote diode & local temp.
→ Typical use: Measuring IC temperatures (e.g. of big FPGAs)
 - ▶ ADS101x 12bit ADC
→ Typical use: Reading DC/DC temperature monitoring outputs
 - ▶ ADT7411 10bit ADC & local temp.
→ Used on some FMCs, e.g. 4DSP FMC116
- ▶ Power manager:
 - ▶ LTC297x (PMBUS) family supported
 - ▶ Built-in monitoring channels
 - ▶ Support for voltage, current and temperature monitoring

Sensors are instantiated by the board impl. using a high-level configuration structure.

Sensors supported by MMC STAMP SDK out of the box:

- ▶ STAMP analog inputs (built-in ADC of MCU), STAMP GPIOs
- ▶ External ADCs & temp. sensors (I2C):
 - ▶ MAX6626 Local temp.
→ Standard for RTMs
 - ▶ LM95214 Remote diode & local temp.
→ Typical use: Measuring IC temperatures (e.g. of big FPGAs)
 - ▶ ADS101x 12bit ADC
→ Typical use: Reading DC/DC temperature monitoring outputs
 - ▶ ADT7411 10bit ADC & local temp.
→ Used on some FMCs, e.g. 4DSP FMC116
- ▶ Power manager:
 - ▶ LTC297x (PMBUS) family supported
 - ▶ Built-in monitoring channels
 - ▶ Support for voltage, current and temperature monitoring

Sensors are instantiated by the board impl. using a high-level configuration structure.

Sensors that are not supported out of the box can be easily integrated by providing a driver function:

```
float (*read_func)(const full_sensor_config_t* arg);
```

MMC SDK: Custom console & IPMI commands

Custom CLI commands

- ▶ Command struct contains command name, argument list description, short help text
- ▶ Callback function signature:

```
void (*mmc_cli_func)(int argc, char** argv);
```

Custom CLI commands

- ▶ Command struct contains command name, argument list description, short help text
- ▶ Callback function signature:

```
void (*mmc_cli_func)(int argc, char** argv);
```

Custom IPMI commands

- ▶ Command struct contains netfn, command code, name and callback
- ▶ Callback function signature:

```
void (*ipmi_cmd_handler)(ipmi_call_t* call);
```

- ▶ Callback function accesses IPMI message payload
 - ▶ req_read_u8(),u16(),u32(): Reads unsigned little-endian value from IPMI request
 - ▶ rsp_write_u8(),u16(),u32(): Writes unsigned little-endian value to IPMI response
 - ▶ rsp_finish(): Finishes a response, sets IPMI completion code

SDK application example: DAMC-FMC1Z7IO

How many LOC necessary to implement a MMC for a modern FMC carrier using the STAMP SDK?

```
$ cloc damc-fmc1z7io/src --by-file --quiet
```

File	blank	comment	code
damc-fmc1z7io/src/board_impl.c	19	27	235
damc-fmc1z7io/src/board_cli.c	22	19	220
damc-fmc1z7io/src/board_payload.c	29	25	109
damc-fmc1z7io/src/board_priv.c	16	22	100
damc-fmc1z7io/src/board_priv.h	17	17	64
damc-fmc1z7io/src/board_eeprom.c	5	11	18
damc-fmc1z7io/src/board_eeprom.h	7	11	13
damc-fmc1z7io/src/main.c	2	11	11
damc-fmc1z7io/src/board_cli.h	2	11	3
SUM:	119	154	773

⇒ MMC implemented in less than 800 LOC total 🎉

Thank you

<https://techlab.desy.de>

Deutsches Elektronen-Synchrotron DESY
A Research Centre of the Helmholtz Association
Notkestr. 85, 22607 Hamburg, Germany